

A Study on Transimpedance Amplifier in 0.35 μm CMOS Technology

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ABSTRACT

This paper presents a design of the transimpedance amplifier using 0.35 μm CMOS technology. In the proposed transimpedance amplifier, feedback resistor R_F of conventional transimpedance amplifier has been replaced by NMOS transistor as an active feedback resistor. This circuit operates at 3.3V power supply voltage and for a photocurrent of 0.5 μA . The proposed transimpedance amplifier having low noise, high gain and large dynamic range. The simulated results of transimpedance gain in single stage and three stage transimpedance amplifiers is 4.43 M Ω and 4.39 M Ω at gate voltage of 0.4V. Power dissipation of single stage and three stage transimpedance amplifier is 602.04 μW and 1.781mW at gate voltage of 2.0V.

Keywords

Transimpedance amplifier, CMOS technology, low noise amplifier, optical receive, negative feedback.

1. INTRODUCTION

A transimpedance amplifier (TIA) is a circuit that converts a current signal into output voltage signal whose voltage is dependent on magnitude of current. The demand of higher data rates transportation over the internet and multimedia communication in recent years result in fast development of high speed optical communication system. Transimpedance amplifiers are very useful circuit components in optical communication system. Front-end of transimpedance amplifier (TIA) is one of most critical building block at electro optical interface on receiver side, which determines the performance of whole system to a large extent, such as speed, gain, sensitivity and noise etc. The performance of optical interconnection system depends on receiver gain, bandwidth, noise and power consumption. Silicon-based CMOS technology [1] is the only candidate which can achieve the required level of integration with reasonable speed, gain, cost, power consumption.

The transimpedance amplifier [2] uses a closed loop circuits as shown in figure 1. This circuit allows not only to avoid the problem of the dynamic range, but also to obtain a trade-off between the high and low impedance configuration. It is relatively high bandwidth and dynamic range as well as a good noise level.

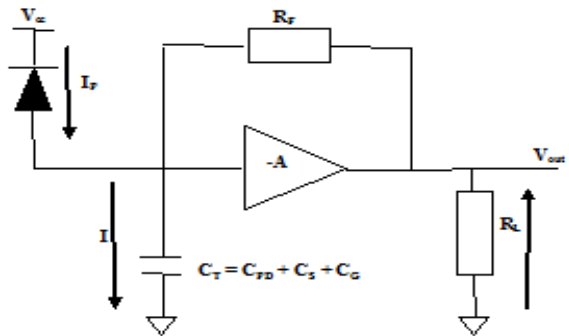


Figure 1: Block diagram of transimpedance amplifier used in an optical receiver

The bandwidth can be improved by increasing the open loop gain of amplifier, whereas when transmission speed is increased, the number of stages composing the amplifier [3] as well as its open loop gain is necessarily reduced. In this paper, transimpedance amplifier parameters such as transimpedance gain, power consumption and output voltage are studied in 0.35 μm CMOS technology.

2. CIRCUIT DISCRPTION

Figure 2 shows CMOS transimpedance amplifier circuit used a push-pull inverter at the input to maximize the transconductance of amplifier [4] and increases its gain bandwidth product (GBP).

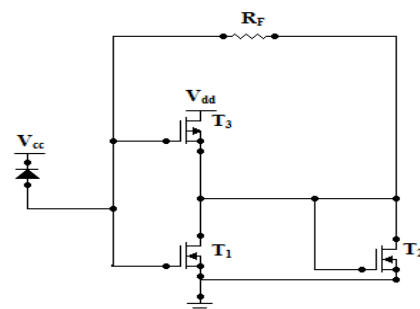


Figure 2: CMOS transimpedance amplifier

The transimpedance amplifier takes a current from input and converts it into a voltage signal. The transistor T1 and T3 from the inverter while T2 is added to increases the bandwidth and minimize the miller effect.

The expression of gain for transimpedance amplifier will be:

$$A_O = \frac{V_{out}}{V_{in}} = \frac{g_{m1} + g_{m2}}{g_{m2}} \quad (1)$$

where: g_{m1} , g_{m2} , g_{m3} = transconductance of T1, T2, T3 transistor,
Another expression of gain for transimpedance amplifier given by:

$$A_o = \alpha + \sqrt{\frac{\mu_p}{\mu_n} \beta (1 + \alpha)} \quad (2)$$

where:

$$\alpha = \frac{W_1 L_2}{W_2 L_1} \quad \text{and} \quad \beta = \frac{W_3 L_2}{W_2 L_3} \quad (3)$$

2.1 Proposed Single Stage Transimpedance Amplifier

Proposed single stage transimpedance amplifier consists of three NMOS transistor and one PMOS transistor. A photocurrent of $0.5\mu\text{A}$ is used in the circuit. In proposed single stage TIA circuit feedback resistor R_F is replaced with NMOS transistor as an active feedback resistor biased by the gate voltage V_G . There is a voltage source V_{dd} of 3.3V which is applied to each PMOS transistor. NMOS transistor having width of $1.0\mu\text{m}$ and length $0.35\mu\text{m}$ is used in the circuit as shown in figure 3. Amplification of signal occurs from input to output. In TIA output is taken at terminal V_{out} , and a portion of output given feedback to the input of the amplifier.

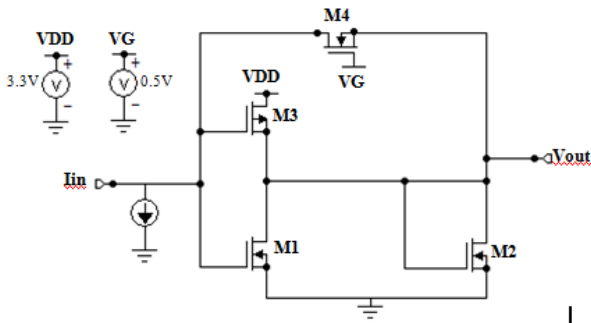


Figure 3: Proposed single stage CMOS transimpedance amplifier

2.2 Proposed Three Stages Transimpedance Amplifier

Three stages transimpedance amplifier consist of three identical cascaded stages having seven NMOS transistor and three PMOS transistor. A photocurrent of $0.5\mu\text{A}$ is used in the circuit. In proposed three stages TIA circuit feedback resistor R_F is replaced with NMOS transistor as an active feedback resistor biased by the gate voltage V_G . There is a voltage source of V_{DD} of 3.3V which is applied to each PMOS transistor. NMOS transistor having width of $1\mu\text{m}$ and length of $0.35\mu\text{m}$ and PMOS transistor having width of $2\mu\text{m}$ and length $0.35\mu\text{m}$ used in the circuit as shown in figure 4.

The feedback resistor will be determined using

$$R_F = \frac{1}{\frac{W}{L} \mu C_{OX} (V_{GS} - V_T)} \quad (4)$$

where W =width, L = length, V_{GS} = gate to source voltage, V_T = threshold voltage

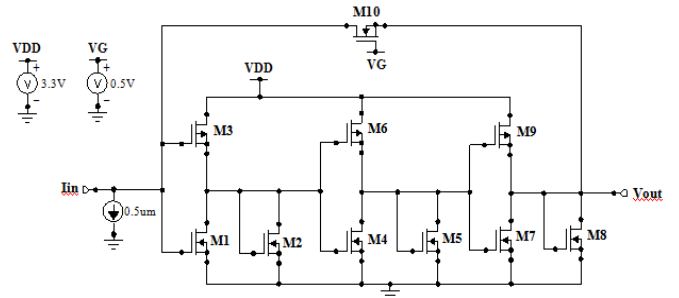


Figure 4: Proposed three stages CMOS transimpedance amplifier

The bandwidth of transimpedance amplifier is approximately equal to:

$$f_{-3dB} = \frac{1 + A}{2\pi R_F C_T} \quad (5)$$

The stability of the system is related to A, and total gain of the system must be controlled. This is given by

$$A = A_o^3 \quad (6)$$

Where A_o is the open loop gain of the single stage

3. RESULTS AND DISCUSSION

3.1 Single Stage TIA

Table 1 shows output voltage, power consumption, transimpedance gain level with varying the magnitude of gate voltage V_G [0.4 – 2.0] V for single stage TIA [Figure 3]. Power consumption varies from [955.21 – 602.40] μW with the variation in magnitude of gate voltage V_G from [0.4 – 2.0] V as shown in figure 6. Output voltage varies from [2.21 – 1.36] V with the variation in magnitude of gate voltage V_G from [0.4 – 2.0] V as shown in figure 5. Transimpedance gain varies from [4.43 – 2.73] $\text{M}\Omega$ with the variation in magnitude of gate voltage V_G from [0.4 – 2.0] V as shown in figure 7.

Table -1: Variation of power and transimpedance gain with gate voltage

Gate voltage V_G (V)	Power consumption (μW)	Output voltage V_{out} (V)	Transimpedance gain ($\text{M}\Omega$)
0.4	955.21	2.2192	4.438
0.8	911.01	2.1537	4.307
1.2	843.07	2.0556	4.111
1.6	743.71	1.8004	3.600
2.0	602.40	1.3665	2.733

Table -2: Variation of power and transimpedance gain with width of NMOS

Width W_n (μm)	Power consumption (μW)	Output voltage V_{out} (V)	Transimpedance gain (M Ω)
0.5	713.06	2.5388	5.077
1.0	946.52	2.2009	4.401
1.5	1088.90	1.9362	3.872
2.0	1169.32	1.7447	3.489
2.5	1216.46	1.6035	3.207
3.0	1245.52	1.4963	2.992

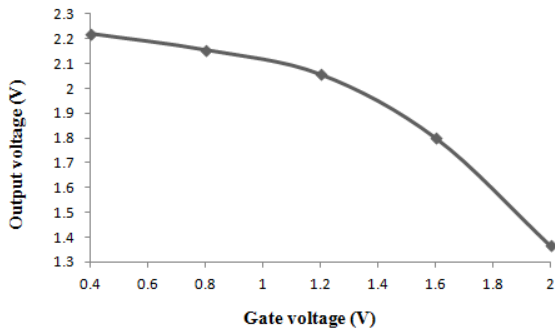


Figure 5: Variation of output voltage of single stage TIA with gate voltage

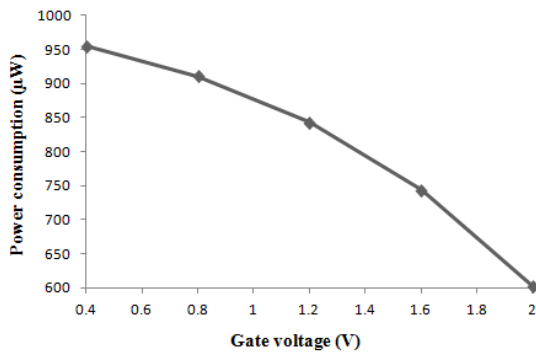


Figure 6: Variation of power of single stage TIA with gate voltage

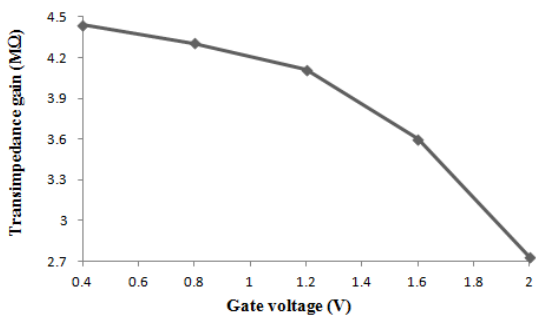


Figure 7: Variation of transimpedance gain of single stage TIA with gate voltage

Table 2 shows output voltage, power consumption, transimpedance gain level with varying the width of NMOS transistor [0.5 – 3.0] μm for single stage TIA [Figure 3]. Power consumption varies from [713.06 – 1245.52] μW with the variation in the width of NMOS transistor from [0.5 – 3.0] μm as shown in figure 9. Output voltage varies from [2.53 – 1.49] V with the variation in the width of NMOS transistor from [0.5 – 3.0] μm as shown in figure 8. Transimpedance gain varies from [5.07 – 2.99] M Ω with the variation in the width of NMOS transistor from [0.5 – 3.0] μm as shown in figure 10.

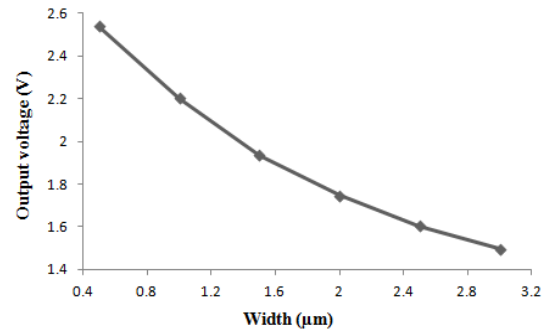


Figure 8: Variation of output voltage of single stage TIA with width of NMOS

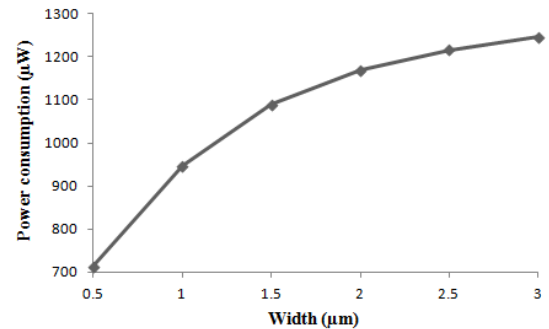


Figure 9: Variation of power of single stage TIA with width of NMOS

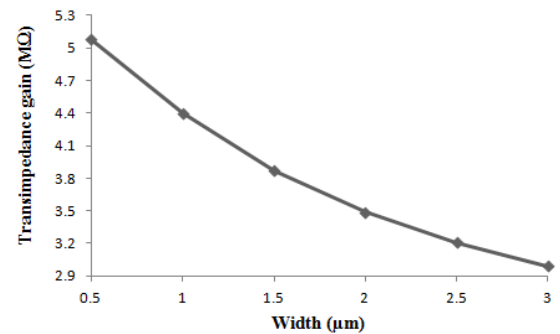


Figure 10: Variation of transimpedance gain of single stage TIA with width of NMOS

Table 3 shows output voltage, power consumption, transimpedance gain level with varying the width of PMOS transistor [1.0 – 3.0] μm for single stage TIA [Figure 3]. Power consumption varies from [576.32 – 1159.82] μW with the variation in the width of PMOS transistor from [1.0 – 3.0] μm as shown in figure 12. Output voltage varies from [1.70 – 2.47] V with the variation in the width of PMOS transistor from [1.0 – 3.0] μm as shown in figure 11. Transimpedance gain varies from [3.40– 4.95] $\text{M}\Omega$ with the variation in the width of PMOS transistor from [1.0 – 3.0] μm as shown in figure 13.

Table -3: Variation of power and transimpedance gain with width of PMOS

Width W_p (μm)	Power consumption (μW)	Output voltage V_{out} (V)	Transimpedance gain ($\text{M}\Omega$)
1.0	576.32	1.7021	3.404
1.4	750.10	1.9411	3.882
1.8	888.37	2.1249	4.249
2.2	998.54	2.2684	4.538
2.6	1087.31	2.3825	4.765
3.0	1159.82	2.4750	4.950

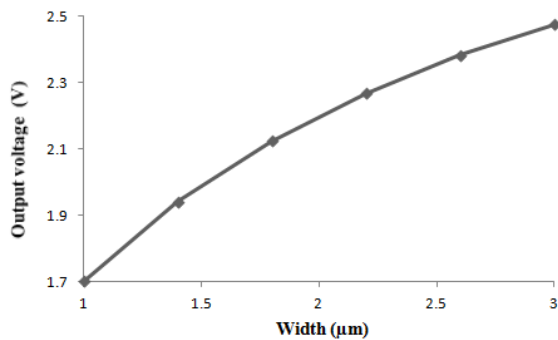


Figure 11: Variation of output voltage of single stage TIA with width of PMOS

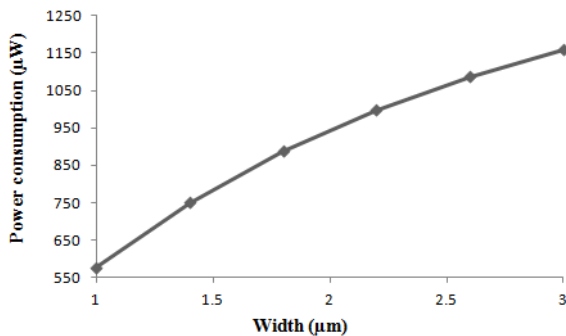


Figure 12: Variation of Power of single stage TIA with width of PMOS

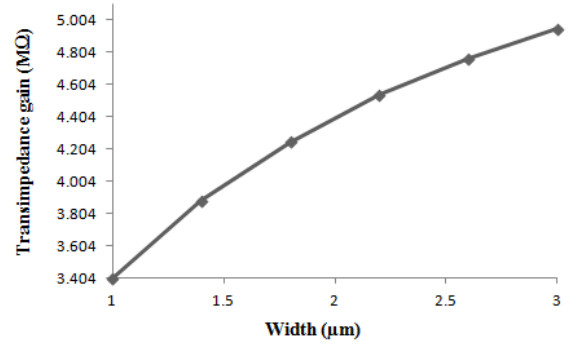


Figure 13: Variation of transimpedance gain of single stage TIA with width of PMOS

3.2 Three Stage TIA

Table 4 shows output voltage, power consumption, transimpedance gain level with varying the magnitude of gate voltage V_G [0.4 – 2.0] V for three stage TIA [Figure 4]. Power consumption varies from [1986.0 – 1781.0] μW with the variation in magnitude of gate voltage V_G from [0.4 – 2.0] V as shown in figure 15. Output voltage varies from [2.19 – 1.55] V with the variation in magnitude of gate voltage V_G from [0.4 – 2.0] V as shown in figure 14. Transimpedance gain varies from [4.39 – 3.11] $\text{M}\Omega$ with the variation in magnitude of gate voltage V_G from [0.4 – 2.0] V as shown in figure 16.

Table -4: Variation of power and transimpedance gain with gate voltage

Gate voltage V_G (V)	Power consumption (μW)	Output voltage V_{out} (V)	Transimpedance gain ($\text{M}\Omega$)
0.4	1986	2.1969	4.393
0.8	1966	2.1915	4.383
1.2	1937	2.1849	4.369
1.6	1945	1.1552	4.310
2.0	1781	1.5578	3.115

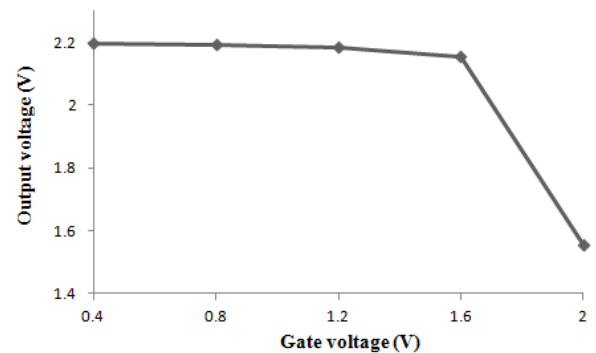


Figure 14: Variation of Output voltage of three stage TIA with gate voltage

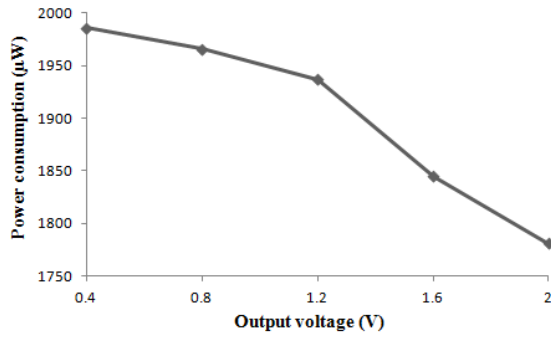


Figure 15: Variation of Power of three stage TIA with gate voltage

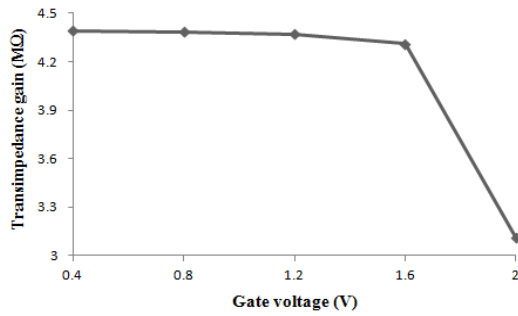


Figure 16: Variation of transimpedance gain of three stage TIA with gate voltage

Table 5 shows output voltage, power consumption, transimpedance gain level with varying the width of NMOS transistor [0.5 – 3.0] μm for three stage TIA [Figure 4]. Power consumption varies from [1432.0 – 2906.0] μW with the variation in the width of NMOS transistor from [0.5 – 3.0] μm as shown in figure 18. Output voltage varies from [2.54 – 1.46] V with the variation in the width of NMOS transistor from [0.5 – 3.0] μm as shown in figure 17. Transimpedance gain varies from [5.08 – 2.93] $\text{M}\Omega$ with the variation in the width of NMOS transistor from [0.5 – 3.0] μm as shown in figure 19.

Table -5: Variation of power and transimpedance gain with width of NMOS

Width W_n (μm)	Power consumption (μW)	Output voltage V_{out} (V)	Transimpedance gain ($\text{M}\Omega$)
0.5	1432	2.5427	5.085
1.0	1984	2.1944	4.388
1.5	2377	1.9180	3.836
2.0	2626	1.7195	3.439
2.5	2762	1.6010	3.202
3.0	2906	1.4688	2.937

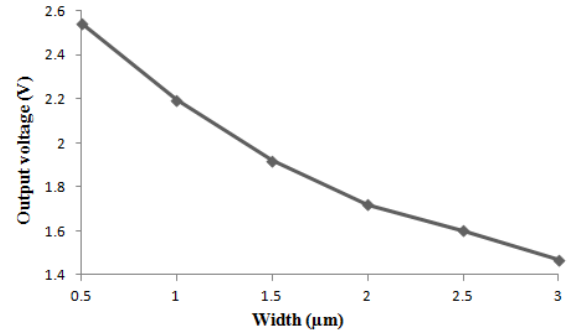


Figure 17: Variation of output voltage of three stage TIA with width of NMOS

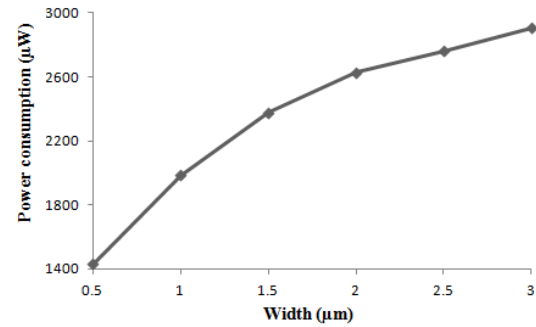


Figure 18: Variation of power of three stage TIA with width of NMOS

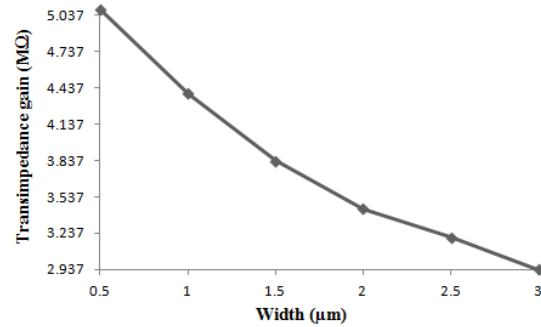


Figure 19: Variation of transimpedance gain of three stage TIA with width of NMOS

Table 6 shows output voltage, power consumption, transimpedance gain level with varying the width of PMOS transistor [1.0 – 3.0] μm for three stage TIA [Figure 4]. Power consumption varies from [1320.0 – 2343.0] μW with the variation in the width of PMOS transistor from [1.0 – 3.0] μm as shown in figure 21. Output voltage varies from [1.65 – 2.47] V with the variation in the width of PMOS transistor from [1.0 – 3.0] μm as shown in figure 20. Transimpedance gain varies from [3.32– 4.95] $\text{M}\Omega$ with the variation in the width of PMOS transistor from [1.0 – 3.0] μm as shown in figure 22.

Table 6: Variation of power and transimpedance gain with width of PMOS

Width Wp (μm)	Power consumption (μW)	Output voltage Vout (V)	Transimpedance gain (MΩ)
1.0	1320	1.6541	3.322
1.4	1560	1.8655	3.731
1.8	1828	2.0712	4.142
2.2	2072	2.2646	4.529
2.6	2220	2.3827	4.765
3.0	2343	2.4773	4.954

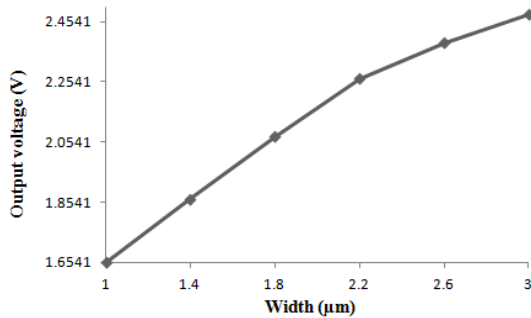


Figure 20: Variation of output voltage of three stage TIA with width of PMOS

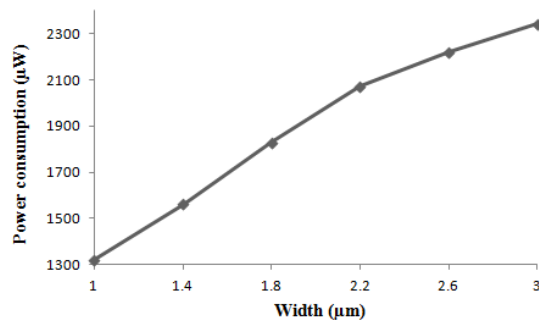


Figure 21: Variation of power of three stage TIA with width of PMOS

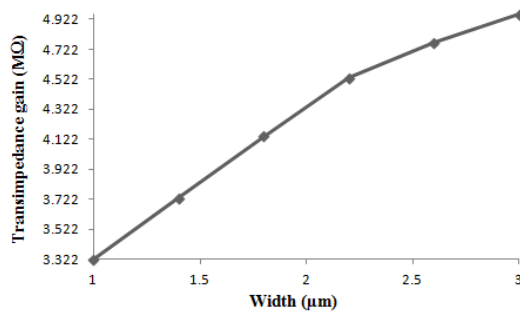


Figure 22: Variation of transimpedance gain of three stage TIA with width of PMOS

4. CONCLUSION

In this paper, the proposed transimpedance amplifier circuit present good performance in parameter such as transimpedance gain, power consumption and output voltage. The different simulation results given by SPICE, shows that the proposed amplifier with NMOS transistor as

an active feedback resistor displays good optimized performance in terms of transimpedance gain, power consumption and output voltage. Transimpedance amplifier is better ability to operate in microampere range. Simulation result shows that transimpedance amplifier provides transimpedance gain in the range [2.73-4.56] MΩ by varying the biased gate voltage V_G in the range [0.4-2.0] V.

5. REFERENCES

- [1] M. Nakamura, N. Ishihara, Y. Akazawa, and H. Kimura, "An instantaneous response CMOS optical receiver ic with wide dynamic range and extremely high sensitivity using feed forward auto-bias adjustment," *IEEE J. Solid-State Circuits*, vol.30, pp. 991-995, September 1995.
- [2] M. Ingels, G. Vander Plas, J. Crols and M. Steyaert, "A CMOS 18THz, 240Mb/s transimpedance amplifier and 155Mb/s LED driver for low cost optical fiber links," *IEEE J. Solid-State Circuits*, vol.29, pp. 1552-1559, July1999.
- [3] Escid Hammoudi and Attari Mokhtar, "Low noise and high bandwidth 0.35μm CMOS transimpedance amplifier," *IEEE Circuit and Systems*, vol.1, pp. 26-29, Jan 2009.
- [4] Shahab Shahdoost, Ali Medi and Namdar Saniei, "A 1.93 Pa/Hz transimpedance amplifier for 2.5Gb/s optical communications", *IEEE Solid-State Circuits*, vol.24, pp.2889-2892, Feb. 2011.
- [5] S.M. Park and C. Toumazou, "Gigahertz Low Noise CMOS Transimpedance Amplifier," *IEEE International Symposium on Circuits and System*, vol.1, pp. 209-212, July 2012.
- [6] Zhenghao Lu, Kiat Seng Yeo, Wei Meng Lim, Manh Anh Do, "Design of a CMOS broadband transimpedance amplifier with active feedback," *IEEE Transactions on Very Large Scale Integration (VLSI) System*, vol. 18, pp. 461-472, March 2010.
- [7] Skawrat Wangtaphan and Varakorn Kasemsuwan, "A high performance thermal noise-canceling transimpedance-based differential amplifier," *IEEE Circuits and Systems*, vol.2, pp. 1- 4, June 2009.
- [8] Firooz Aflatouni and Hossenin Hashemi, "A 1.8mW wideband 57dBΩ transimpedance amplifier in 0.13μm CMOS," *IEEE Radio Frequency Integrated Circuits Symposium*, pp. 57-60, July 2009.
- [9] Liang Han, Mingyan Yu, Lu Zong, "Bandwidth enhancement for transimpedance amplifier in CMOS process," *IEEE Circuit and Systems*, vol.2, pp. 2839-2842, June 2008.
- [10] L. Myunghee, "A quasi-monolithic optical receiver using a standard digital CMOS technology," *Doc. Phil., Electrical and Computer Engineering, Georgia Institute of Technology*, vol. 9, pp. 88-90, January1997.
- [11] M. Ingles and M. Steyaert, "A 1 Gb/s, 0.7 μm CMOS optical receiver with full rail-to-rail Swanson," *IEEE J. Solid-State Circuits*, vol. 34, pp. 971-977. July 1999.
- [12] C. Toumazou and S. M. Park, "Wideband low noise CMOS transimpedance amplifier for gigahertz operation," *Electron. Lett*, vol. 32, pp. 1194-1196, June 1996.